◆ General Description

The GH266A is an integrated Hall sensor with output driver designed for electronic commutation of brush-less DC motor applications. The device includes an on-chip Hall sensor for magnetic sensing, an amplifier that amplifies the Hall voltage, a wave shaping circuit to provide switching hysteresis for noise rejection and two complementary open-drain drivers for sinking large load current. It also includes an internal voltage regulator which allows a wide operating supply voltage ranges.

Placing the device in a variable magnetic field, if the magnetic flux density is larger than threshold B_{OP} , the pin OUT1 will be turned low (on) and pin OUT2 will be turned high (off). This output state is held until the magnetic flux density reverses and falls below B_{RP} , then causes OUT1 to be turned high (off) and OUT2 turned low (on). GH266A is

rated for operation over temperature range from -40°C to +85 $^{\circ}$ C and voltage range from 3.5V to 28V.

The GH266A is available in TO-94 (SIP-4L) package.

Features

- On Chip Hall Effect Sensor
- 3.5~28V Power Supply Voltage
- Drivers Allow 400mA Without Overheating
- Built-in Zener Diodes Protection for Output Driver
- Embedded Over-Temperature Protection
- Precise Magnetic Switching Thresholds

Applications

- Dual-coil Brushless DC Fan
- Dual-coil Brushless DC Motor

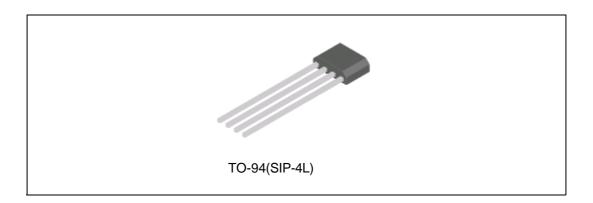


Figure 1. Package Type of GH266A

Ordering Information

Package	Temperature Range	Part Number	Marking ID	Packing Type
TO-94(SIP-4L)	-40 to 85 ℃	GH266AEUB	GH266A	Bulk

♦ Pin Configuration

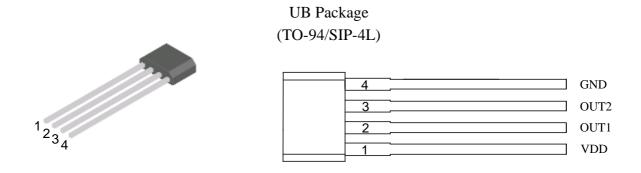


Figure 2. Pin Configuration of GH266A (Front View)

♦ Pin Description

Pin Number	Pin Name	Function	
1	VDD	Power Supply Pin	
2	OUT1	Open-Drain Output Pin 1	
3	OUT2	Open-Drain Output Pin 2	
4	GND	Ground Pin	

◆ Functinal Block Diagram

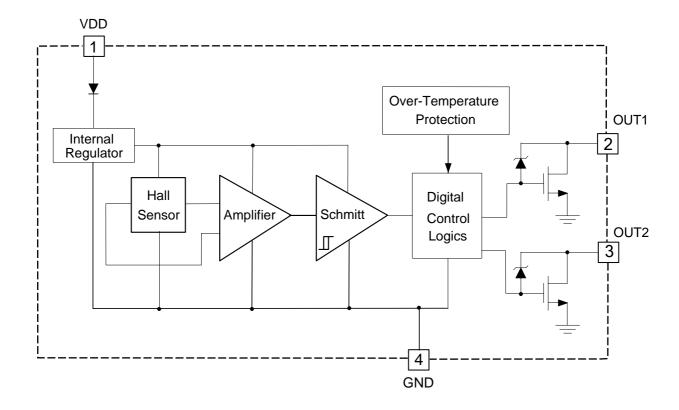


Figure 3. Functional Block Diagram of GH266A



♦ Absolute Maximum Ratings T_A =25°C (Note 1)

Parameter	Symbol	Condition	Value	Unit
Supply Voltage (Continuous)	V _{DD(CONT)}		30	V
Supply Voltage (Peak)	V _{DD(PEAK)}	≤100s	40	V
Supply current (Fault)	I _{DD(FAULT)}		3.5	mA
Continuous current	I _{OUT(CONT)}		400	mA
Hold current	I _{OUT(HOLD)}		600	mA
Peak current	I _{OUT(PEAK)}	≤200μs	800	mA
Power dissipation	P_{D}	TO-94(SIP-4L)	550	mW
Thermal Resistance (Junction to Ambient)	θ_{JA}	TO-94(SIP-4L)	227	°C/W
Thermal Resistance (Junction to Case)	θ_{JC}	TO-94(SIP-4L)	49	°C/W
Operating Junction temperature	T_{J}		-40 to 150	${\mathbb C}$
Storage temperature	T_{STG}		-55 to 160	$^{\circ}$
Output Clamp Voltage of Zener Diode	V_{Z}		43	V
Magnetic Flux Density	В		Unlimited	Gauss
IR-Reflow Lead Temperature	T_{P}	10s	260	$^{\circ}$

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Power Supply Voltage	$V_{ m DD}$	3.5	28	V
Operation Temperature	T_A	-40	85	$^{\circ}\!$

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated above "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.



♦ Electrical Characteristics

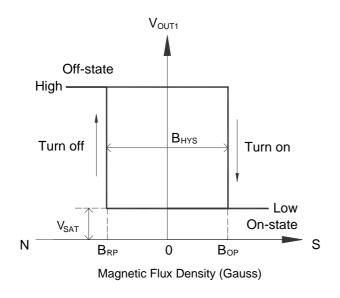
 $V_{DD} = 24V$, $T_A = 25$ °C, unless otherwise specified.

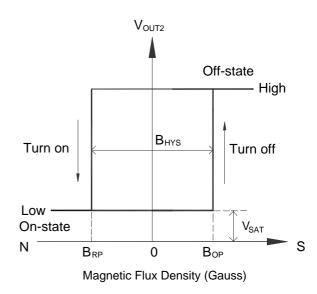
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	V_{DD}	Operating	3.5	-	28	V
Supply Current	I_{DD}	Output open	-	1.3	2.5	mA
Output Current	I_{OUT}		-		400	mA
Output Leakage Current	I _{LEAKAGE}	V _{OUT} =28V	-	0.1	10	μΑ
Output Driver ON-Resistance	D	T _A =25 ℃	-	1.0	1.4	Ohm
Output Bilver Orv Resistance	K _{DSON}	$T_{A}=85^{\circ}\text{C}$	1.4	1.8	Ohm	
Thermal Shutdown Threshold	T_{SD}		165	-	-	$^{\circ}$ C

◆ Magnetic Characteristics

 V_{DD} =12V, T_A =25°C, unless otherwise specified.

Parameter	Symbol	Min	Тур	Max	Unit
Operating Point	B _{OP}	-	30	60	Gauss
Releasing Point	B _{RP}	-60	-30	-	Gauss
Hysteresis	B _{HYS}	-	60	-	Gauss





◆ Typical Application

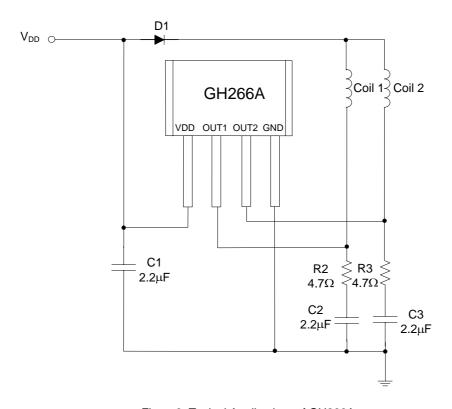


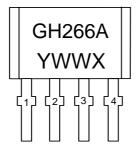
Figure 6. Typical Application of GH266A

Note:

- 1. D1 is an ordinary diode used to filter the noise from VDD and It is optional.
- 2. $C1=C2=C3=2.2\mu F$ typical, electrolytic capacitors are better. They should be fine tuned based on system design.
- 3. $R2=R3=4.7\Omega$ typical. They can be cancelled according to system requirement.

Marking Information

(TO-94/SIP-4L)



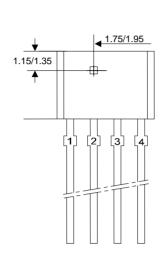
GH266A: Part No.

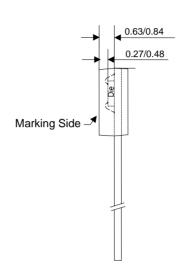
Y: Year, 0~9, ex: "7"=2017 WW: Nth Week, 01~52

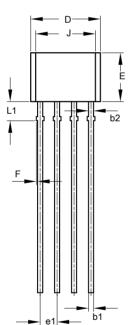
X: Internal Code

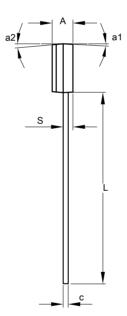
♦ Pacakge Information

(UB: TO-94/SIP-4L) Unit: mm









Size	MIN.	MAX.	TYP.			
Α	1.45	1.65	1.55			
b1	0.38	0.44	0.40			
b2	-	-	0.48			
С	0.35	0.45	0.40			
D	5.12	5.32	5.22			
e1	1.24	1.30	1.27			
Е	3.55	3.75	3.65			
F	0.00	0.20	-			
J	4.10	4.30	4.20			
L	14.00	14.60	14.30			
L1	1.32	1.52	1.42			
S	0.63	0.83	0.73			
a1	-	5°	3°			
a2	4°	7°	5°			
а3	10°	12°	11°			
a4	5°	7°	6°			
Unit: mm						

